

MEDIA RELEASE

A*STAR IME, STATS CHIPPAC AND QUALCOMM COLLABORATE TO DEVELOP LOW COST INTERPOSER TECHNOLOGY

1. Singapore 29 May, 2013 -- Singapore's A*STAR Institute of Microelectronics (IME), Qualcomm Technologies Inc., a wholly owned subsidiary of Qualcomm Incorporated, and STATS ChipPAC have announced a collaboration to develop technology building blocks for Low Cost Interposers (LCI) for 2.5D ICs.
 2. "2.5D/3D IC technology provides ample opportunities to further increase functionality and performance of semiconductor ICs. A collaborative approach is necessary for the industry to harness 2.5D/3D IC technologies successfully," said Prof. Dim-Lee Kwong, Executive Director of IME. "IME's consortium with Qualcomm Technologies and STATS ChipPAC focuses on pushing forward cost-effective manufacturing approaches in a timely manner."
 3. "This initiative extends our R&D efforts in the 2.5D/3D technologies and is another example of our investment in the silicon technology space," said Jim Lederer, executive vice president and general manager, Qualcomm Technologies. "The collaboration with IME and STATS ChipPAC will help us support the ability to optimize 2.5D/3D IC technology and achieve cost and performance needs."
 4. "We are pleased to be part of this consortium to develop 2.5D technology solutions to address issues related to high volume manufacturing of 2.5D interposers," said Dr. Han Byung Joon, Executive Vice President and Chief Technology Officer, STATS ChipPAC. "This collaboration, in conjunction with STATS ChipPAC's proven expertise in manufacturing 2.5D/3D ICs, expands our strategic relationship with Qualcomm Technologies and IME."
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About Institute of Microelectronics (IME)

The Institute of Microelectronics (IME) is a research institute of the Science and Engineering Research Council of the Agency for Science, Technology and Research (A*STAR). Positioned to bridge the R&D between academia and industry, IME's mission is to add value to Singapore's semiconductor industry by developing strategic competencies, innovative technologies and intellectual property; enabling enterprises to be technologically competitive; and cultivating a technology talent pool to inject new knowledge to the industry. Its key research areas are in integrated circuits design, advanced packaging, bioelectronics and medical devices, MEMS, nanoelectronics, and photonics. For more information about IME, please visit <http://www.ime.a-star.edu.sg>.

About Agency for Science, Technology and Research (A*STAR)

The Agency for Science, Technology and Research (A*STAR) is the lead agency for fostering world-class scientific research and talent for a vibrant knowledge-based and innovation-driven Singapore. A*STAR oversees 14 biomedical sciences, and physical sciences and engineering research institutes, and seven consortia & centre, which are located in Biopolis and Fusionopolis, as well as their immediate vicinity. A*STAR supports Singapore's key economic clusters by providing intellectual, human and industrial capital to its partners in industry. It also supports extramural research in the universities, hospitals, research centres, and with other local and international partners. For more information about A*STAR, please visit <http://www.a-star.edu.sg>.

About Qualcomm Incorporated

Qualcomm Incorporated (NASDAQ: QCOM) is the world leader in 3G, 4G and next-generation wireless technologies. Qualcomm Incorporated includes Qualcomm's licensing business, QTL, and the vast majority of its patent portfolio. Qualcomm Technologies, Inc., a wholly-owned subsidiary of Qualcomm Incorporated, operates, along with its subsidiaries, substantially all of Qualcomm's engineering, research and

development functions, and substantially all of its products and services businesses, including its semiconductor business, QCT. For more than 25 years, Qualcomm ideas and inventions have driven the evolution of digital communications, linking people everywhere more closely to information, entertainment and each other. For more information, visit Qualcomm's website, OnQ blog, Twitter and Facebook pages.

About STATS ChipPAC

STATS ChipPAC Ltd. (SGX-ST Code: S24) is a leading service provider of semiconductor packaging design, assembly, test and distribution solutions in diverse end market applications including communications, digital consumer and computing. With global headquarters in Singapore, STATS ChipPAC has design, research and development, manufacturing or customer support offices throughout Asia, the United States and Europe. STATS ChipPAC is listed on the SGX-ST. Further information is available at www.statschippac.com. Information contained in this website does not constitute a part of this release.

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